MOSFET - N-Channel, SUPREMOS, FRFET

600 V, 48.5 A, 65 m Ω

FCH47N60NF

Description

The SUPREMOS® MOSFET is ON Semiconductor's next generation of high voltage super-junction (SJ) technology employing a deep trench filling process that differentiates it from the conventional SJ MOSFETs. This advanced technology and precise process control provides lowest Rsp on-resistance, superior switching performance and ruggedness. SUPREMOS MOSFET is suitable for high frequency switching power converter applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications. SUPREMOS FRFET® MOSFET's optimized body diode reverse recovery performance can remove additional component and improve system reliability.

Features

- 650 V @ $T_J = 150$ °C
- Typ. $R_{DS(on)} = 57.5 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. Q_g = 240 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 420 pF)
- 100% Avalanche Tested
- This Device is Pb-Free and is RoHS Compliant

Applications

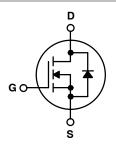
- Solar Inverter
- AC-DC Power Supply



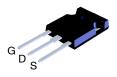
ON Semiconductor®

www.onsemi.com

V _{DS}	R _{DS(ON)} MAX	I _D MAX	
600 V	65 mΩ @ 10 V	48.5 A	



N-CHANNEL MOSFET



TO-247-3LD CASE 340CK

MARKING DIAGRAM



Y = ON Semiconductor Logo

&Z = Assembly Plant Code &3 = Numeric Date Code &K = Lot Code

FCH47N60NF = Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

MOSFET MAXIMUM RATINGS ($T_C = 25^{\circ}C$ unless otherwise noted)

Symbol		Parameter	FCH47N60NF	Unit	
V_{DSS}	Drain to Source Voltage		600	V	
V_{GSS}	Gate to Source Voltage		±30	V	
I _D	Drain Current	− Continuous (T _C = 25°C)	45.8	Α	
		− Continuous (T _C = 100°C)	28.9		
I _{DM}	Drain Current	- Pulsed (Note 1)	137.4	Α	
E _{AS}	Single Pulsed Avalanche Energy (Note	2926	mJ		
I _{AR}	Avalanche Current (Note 1)		15.3	Α	
E _{AR}	Repetitive Avalanche Energy (Note 1)		3.7	mJ	
dv/dt	MOSFET dv/dt		100	V/ns	
	Peak Diode Recovery dv/dt (Note 3)		50		
P_{D}	Power Dissipation	(T _C = 25°C)	368	W	
		– Derate above 25°C	2.94	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to + 150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Second		300	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. $I_{AS} = 15.3 \text{ A}$, $R_{G} = 25 \Omega$, starting $T_{J} = 25 ^{\circ}\text{C}$ 3. $I_{SD} \le 45.8 \text{ A}$, $di/dt \le 1200 \text{ A}/\mu\text{s}$, $V_{DD} \le 380 \text{ V}$, starting $T_{J} = 25 ^{\circ}\text{C}$

THERMAL CHARACTERISTICS

Symbol	Parameter	FCH47N60NF	Unit
$R_{ heta JC}$	Thermal Resistance, Junction to Case, Max.	0.34	°C/W
$R_{ heta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Package Method	Reel Size	Tape Width	Quantity
FCH47N60NF	FCH47N60NF	TO-247-3LD	Tube	N/A	N/A	30 Units

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
OFF CHARA	ACTERISTICS			-		
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 1 mA, V _{GS} = 0 V, T _C = 25°C	600	-	-	V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I _D = 1 mA, Referenced to 25°C	-	0.78	-	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 480 V, V _{GS} = 0 V	_	-	10	μΑ
		V _{DS} = 480 V, V _{GS} = 0 V, T _C = 125°C	_	-	100	
I _{GSS}	Gate to Body Leakage Current	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0 \text{ V}$	_	-	±100	nA
ON CHARA	CTERISTICS					
V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	3	-	5	V
R _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 23.5 A	-	57.5	65.0	mΩ
9FS	Forward Transconductance	V _{DS} = 40 V, I _D = 23.5 A	-	52	100	S
DYNAMIC C	HARACTERISTICS		•	•		
C _{iss}	Input Capacitance	V _{DS} = 100 V, V _{GS} = 0 V,	-	4600	6120	pF
C _{oss}	Output Capacitance	f = 1 MHz	_	195	260	pF
C _{rss}	Reverse Transfer Capacitance	1	_	3.0	5.0	pF
C _{oss}	Output Capacitance	V _{DS} = 380 V, V _{GS} = 0 V, f = 1 MHz	-	108	-	pF
C _{oss(eff.)}	Effective Output Capacitance	V _{DS} = 0 V to 380 V, V _{GS} = 0 V	-	492	-	pF
Q _{g(tot)}	Total Gate Charge at 10 V	V _{DS} = 380 V, I _D = 23.5 A,	_	121	157	nC
Q _{gs}	Gate to Source Gate Charge	V _{GS} = 10 V (Note 4)	_	23	-	nC
Q _{gd}	Gate to Drain "Miller" Charge	1`	_	47	-	nC
ESR	Equivalent Series Resistance (G-S)	f = 1 MHz	-	0.9	-	Ω
SWITCHING	CHARACTERISTICS		•	•		
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 380 \text{ V}, I_D = 23.5 \text{ A},$	_	34	78	ns
t _r	Turn-On Rise Time	$R_G = 4.7 \Omega$ (Note 4)	_	22	54	ns
t _{d(off)}	Turn-Off Delay Time	1	_	117	244	ns
t _f	Turn-Off Fall Time	1	_	4	18	ns
DRAIN-SOU	RCE DIODE CHARACTERISTICS			•	<u> </u>	
I _S	Maximum Continuous Drain to Source Diode Forward Current		-	-	47	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	141	Α
V _{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0 V, I _{SD} = 23.5 A	-	-	1.2	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _{SD} = 23.5 A,	-	169	-	ns
Q _{rr}	Reverse Recovery Charge	dI _F /dt = 100 A/μs		1.3	-	μС
	compatric performance is indicated in the Floatricel Characteristics for the listed test		1000	·	·	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Essentially Independent of Operating Temperature Typical Characteristics.

TYPICAL CHARACTERISTICS

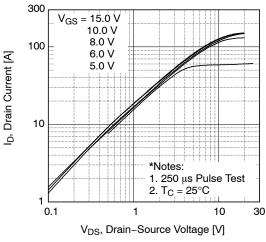


Figure 1. On-Region Characteristics

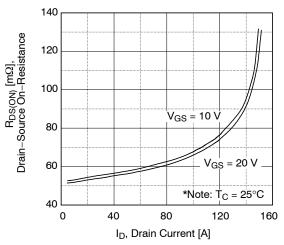


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

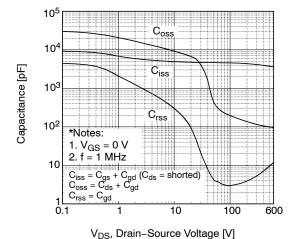


Figure 5. Capacitance Characteristics

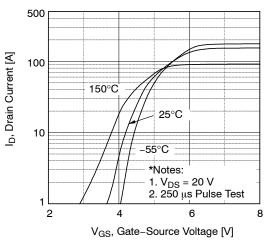


Figure 2. Transfer Characteristics

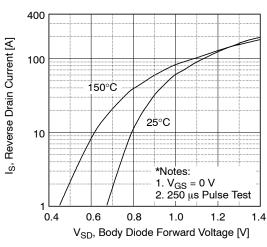


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

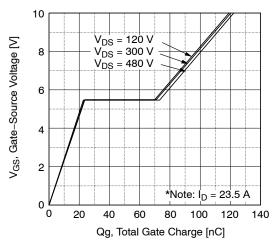


Figure 6. Gate Charge Characteristics

TYPICAL CHARACTERISTICS (continued)

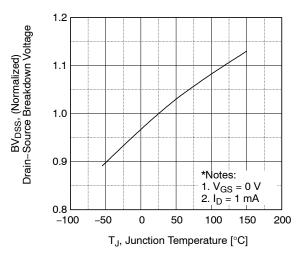


Figure 7. Breakdown Voltage Variation vs. Temperature

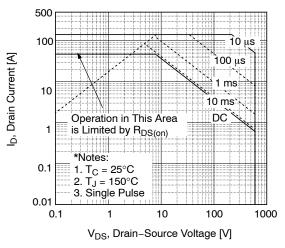


Figure 9. Maximum Safe Operating Area

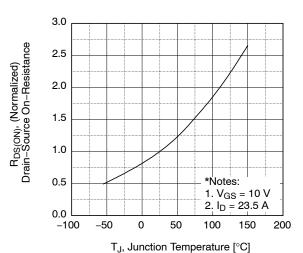


Figure 8. On–Resistance Variation vs. Temperature

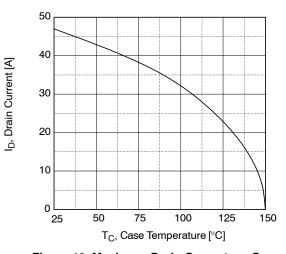


Figure 10. Maximum Drain Current vs. Case Temperature

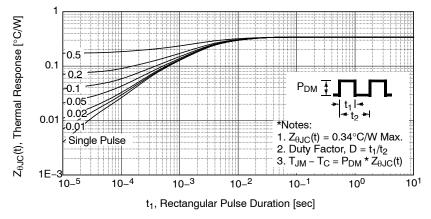


Figure 11. Transient Thermal Response Curve

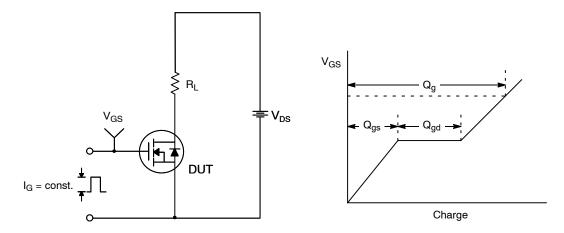


Figure 12. Gate Charge Test Circuit & Waveform

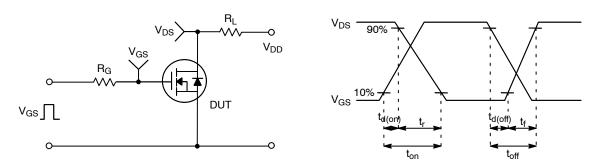


Figure 13. Resistive Switching Test Circuit & Waveforms

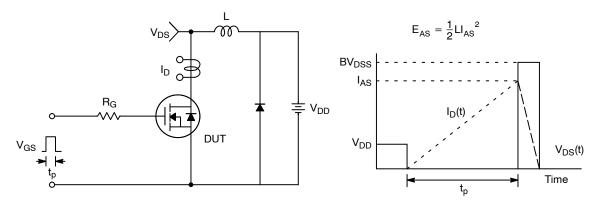


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

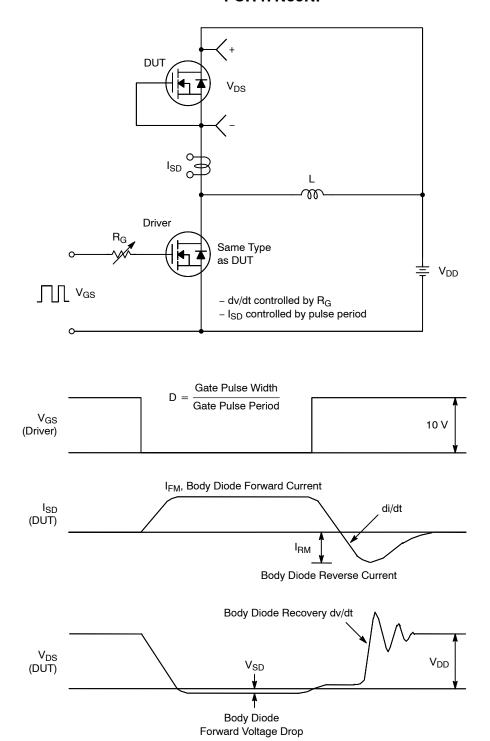


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

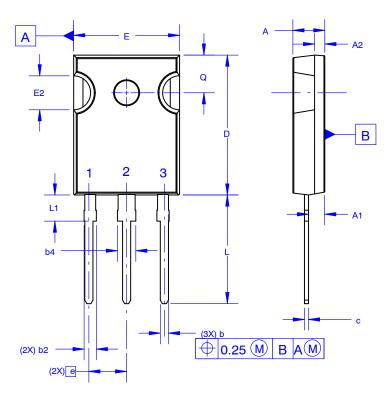
SUPREMOS is a registered trademark of Semiconductor Components Industries, LLC (SCILLC) or its subsidiaries in the United States and/or other countries.

FREFET is a registered trademark of Semiconductor Components Industries, LLC (SCILLC) or its subsidiaries in the United States and/or other countries.



TO-247-3LD SHORT LEAD

CASE 340CK ISSUE A



NOTES: UNLESS OTHERWISE SPECIFIED.

- A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DRAWING CONFORMS TO ASME Y14.5 2009.
- D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
- E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

GENERIC MARKING DIAGRAM*



XXXX = Specific Device Code

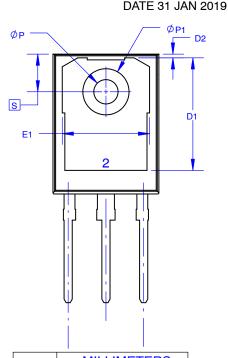
A = Assembly Location

Y = Year

WW = Work Week

ZZ = Assembly Lot Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



DIM	MILLIMETERS				
וווט	MIN	NOM	MAX		
Α	4.58	4.70	4.82		
A1	2.20	2.40	2.60		
A2	1.40	1.50	1.60		
b	1.17	1.26	1.35		
b2	1.53	1.65	1.77		
b4	2.42	2.54	2.66		
С	0.51	0.61	0.71		
D	20.32	20.57	20.82		
D1	13.08	~	~		
D2	0.51	0.93	1.35		
Ш	15.37	15.62	15.87		
E1	12.81	~	~		
E2	4.96	5.08	5.20		
е	~	5.56	~		
L	15.75	16.00	16.25		
L1	3.69	3.81	3.93		
ØΡ	3.51	3.58	3.65		
Ø P1	6.60	6.80	7.00		
Q	5.34	5.46	5.58		
S	5.34	5.46	5.58		

DOCUMENT NUMBER:	98AON13851G	Electronic versions are uncontrolled except when accessed directly from the Document Repository Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	TO-247-3LD SHORT LEAD		PAGE 1 OF 1	

onsemi and ONSEMI are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI., and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems. or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

 $\textbf{Technical Library:} \ \underline{www.onsemi.com/design/resources/technical-documentation}$

onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support

For additional information, please contact your local Sales Representative at

www.onsemi.com/support/sales